

## Fuji Discrete Package IGBT

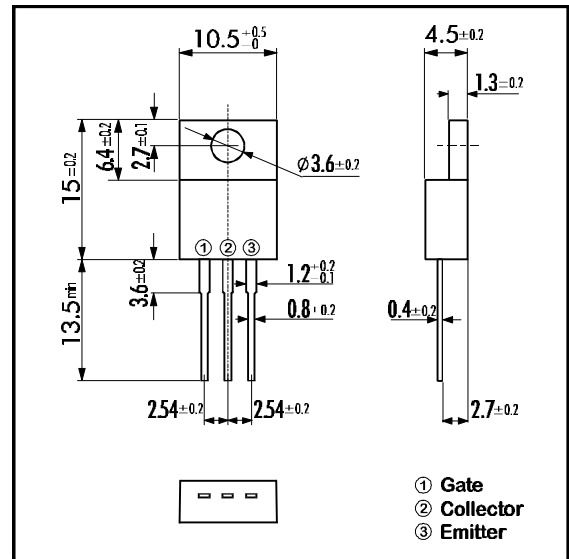
## ■ Outline Drawing

### ■ Features

- Square RBSOA
- Low Saturation Voltage
- Less Total Power Dissipation
- Minimized Internal Stray Inductance

### ■ Applications

- High Power Switching
- A.C. Motor Controls
- D.C. Motor Controls
- Uninterruptible Power Supply

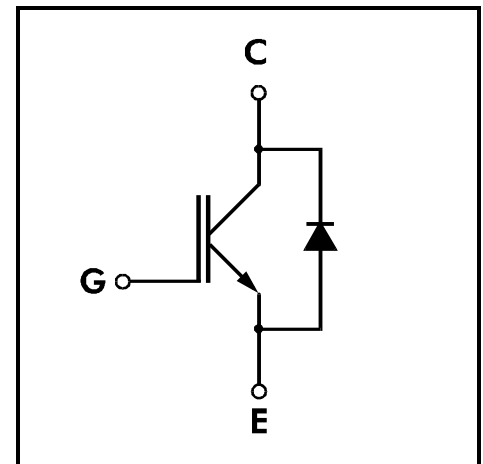


## ■ Maximum Ratings and Characteristics

### • Absolute Maximum Ratings (T<sub>c</sub>=25°C)

Items	Symbols	Ratings	Units
Collector-Emitter Voltage	V <sub>CES</sub>	600	V
Gate -Emitter Voltage	V <sub>GES</sub>	± 20	V
Collector Current	DC T <sub>c</sub> = 25°C	I <sub>C 25</sub>	20
	DC T <sub>c</sub> =100°C	I <sub>C 100</sub>	10
	1ms T <sub>c</sub> = 25°C	I <sub>C PULSE</sub>	80
IGBT Max. Power Dissipation	P <sub>C</sub>	75	W
FWD Max. Power Dissipation	P <sub>C</sub>	35	W
Operating Temperature	T <sub>j</sub>	+150	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +125	°C
Mounting Screw Torque		40	Nm

## ■ Equivalent Circuit



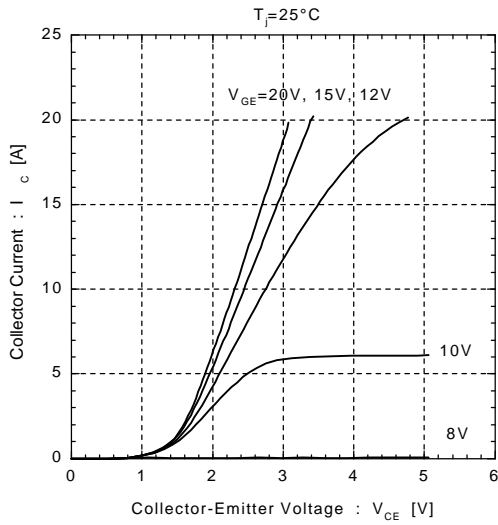
### • Electrical Characteristics (at T<sub>j</sub>=25°C)

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units	
Zero Gate Voltage Collector Current	I <sub>CES</sub>	V <sub>GE</sub> =0V V <sub>CE</sub> =600V			1.0	mA	
Gate-Emitter Leakage Current	I <sub>GES</sub>	V <sub>CE</sub> =0V V <sub>GE</sub> =± 20V			20	μA	
Gate-Emitter Threshold Voltage	V <sub>GE(th)</sub>	V <sub>GE</sub> =20V I <sub>C</sub> =10mA	5.5		8.5	V	
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V I <sub>C</sub> =10A			3.0	V	
Input capacitance	C <sub>ies</sub>	V <sub>GE</sub> =0V		700		pF	
Output capacitance	C <sub>oes</sub>	V <sub>CE</sub> =10V		150			
Reverse Transfer capacitance	C <sub>res</sub>	f=1MHz		20			
Switching Time	Turn-on Time	t <sub>ON</sub>	V <sub>CC</sub> =300V			1.2	μs
		t <sub>r</sub>	I <sub>C</sub> =10A			0.6	
	Turn-off Time	t <sub>OFF</sub>	V <sub>GE</sub> =±15V			1.0	
		t <sub>f</sub>	R <sub>G</sub> =220Ω			0.35	
	Turn-on Time	t <sub>ON</sub>	V <sub>CC</sub> =300V		0.16		μs
		t <sub>r</sub>	I <sub>C</sub> =10A		0.11		
	Turn-off Time	t <sub>OFF</sub>	V <sub>GE</sub> =+15V		0.30		
		t <sub>f</sub>	R <sub>G</sub> =22Ω			0.35	
Diode Forward On-Voltage	V <sub>F</sub>	I <sub>F</sub> =10A V <sub>GE</sub> =0V			3.0	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =10A, V <sub>GE</sub> =-10V, di/dt=100A/μs			300	ns	

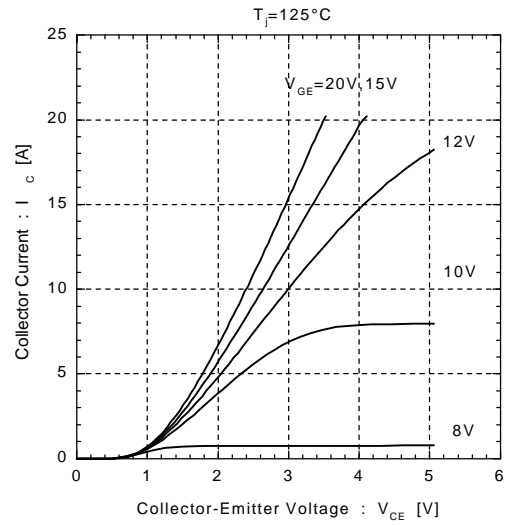
### • Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	R <sub>th(j-c)</sub>	IGBT			1.66	°C/W
	R <sub>th(j-e)</sub>	Diode			3.57	

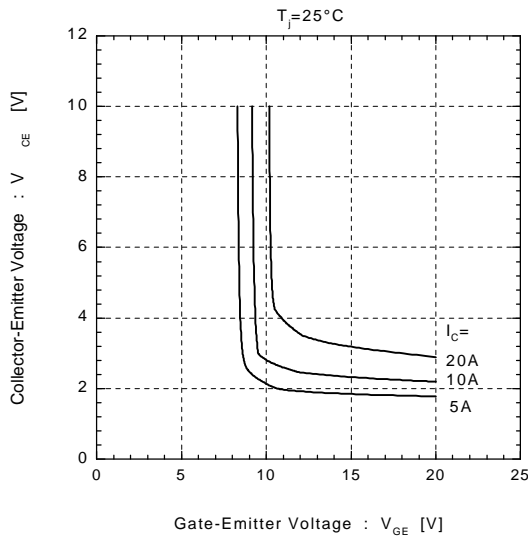
Collector Current vs. Collector-Emitter Voltage



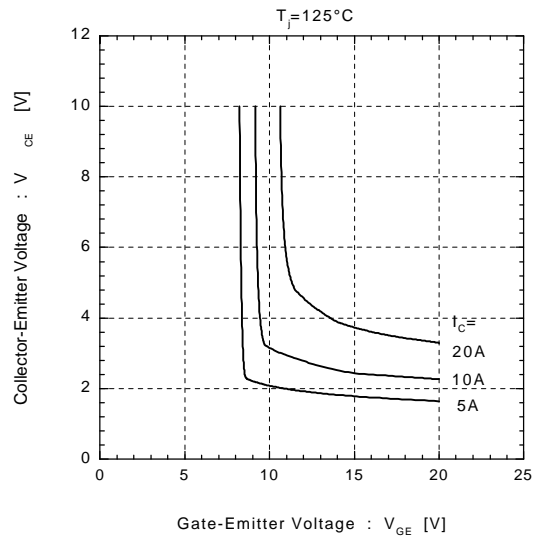
Collector Current vs. Collector-Emitter Voltage



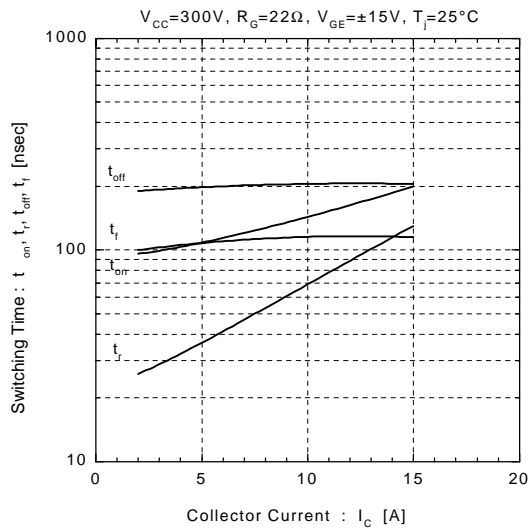
Collector-Emitter Voltage vs. Gate-Emitter Voltage



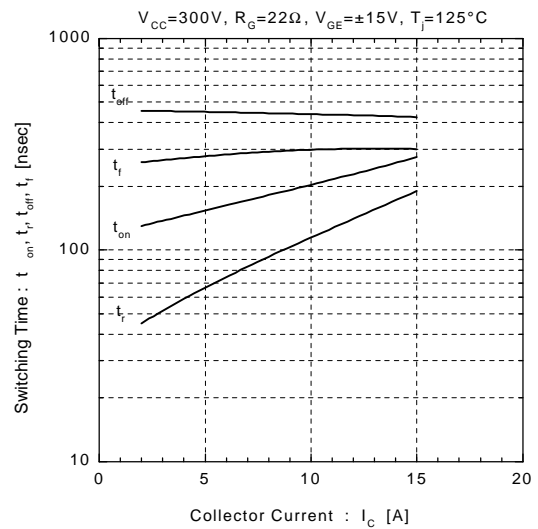
Collector-Emitter Voltage vs. Gate-Emitter Voltage

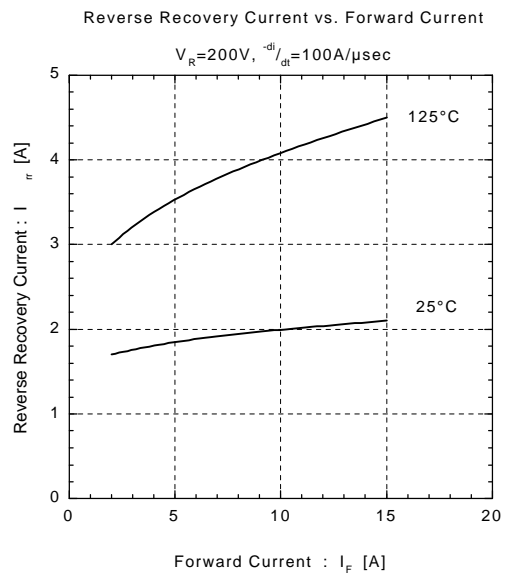
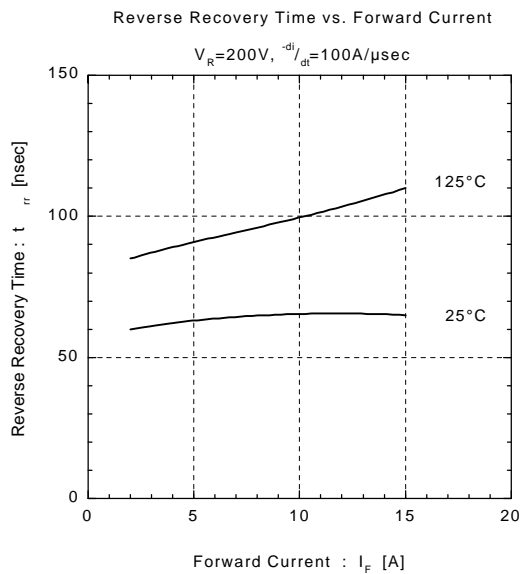
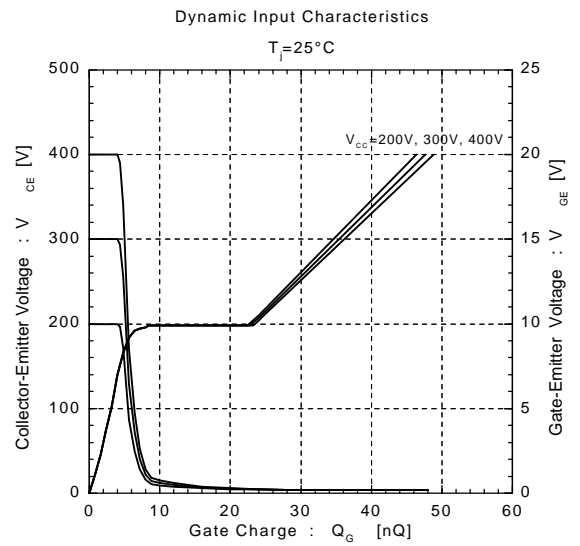
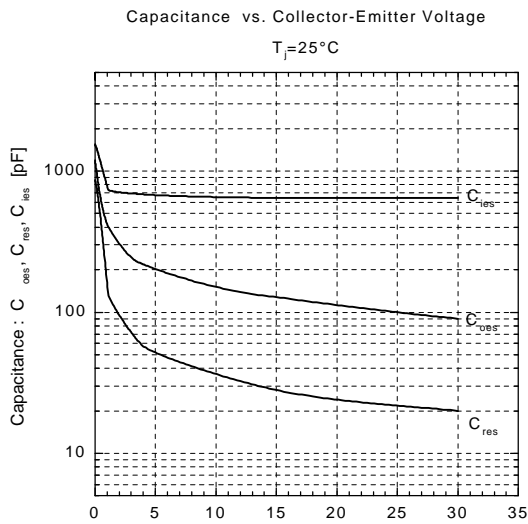
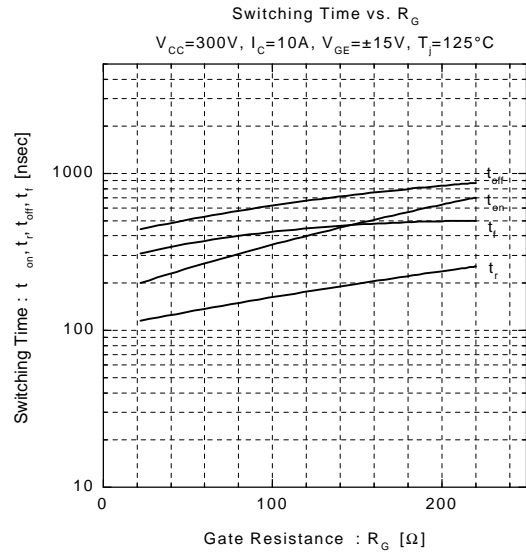
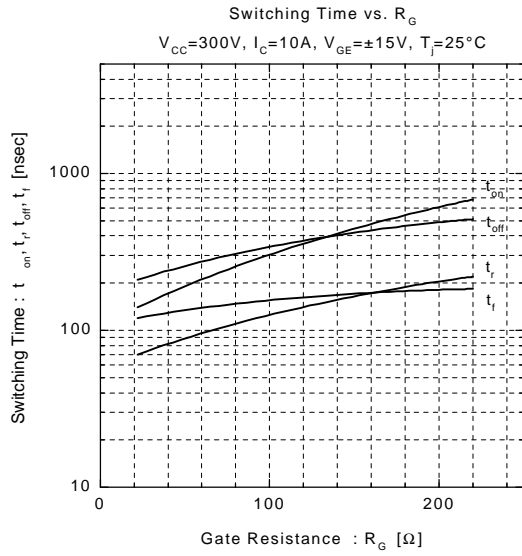


Switching Time vs. Collector Current

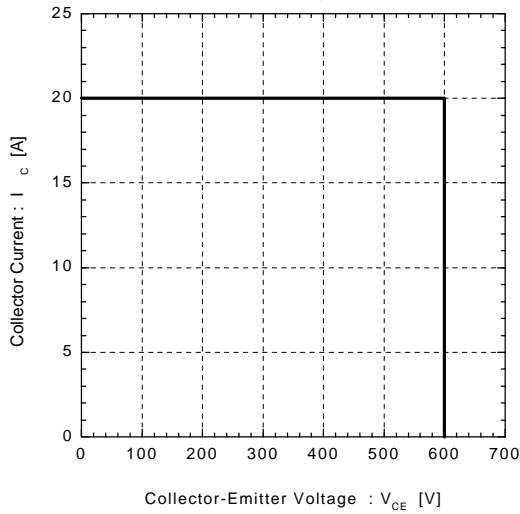


Switching Time vs. Collector Current

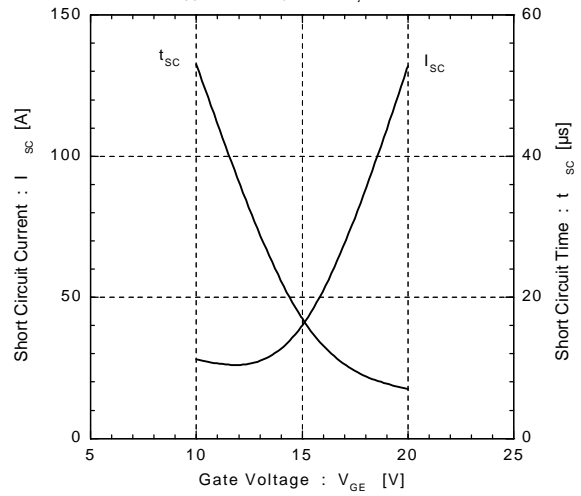




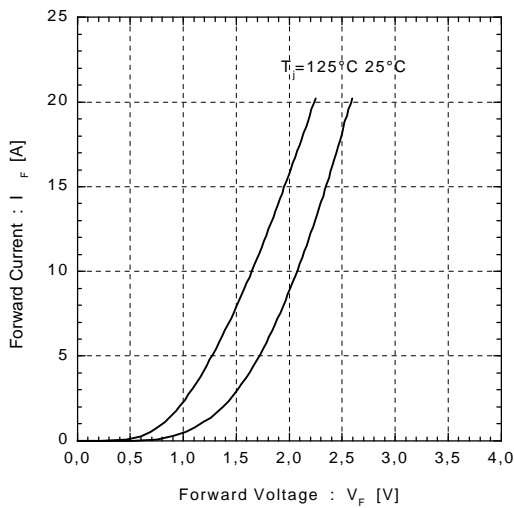
Reverse Biased Safe Operating Area  
 $+V_{GE}=15V, -V_{GE}\leq 15V, T_J\leq 125^\circ C, R_G\geq 22\Omega$



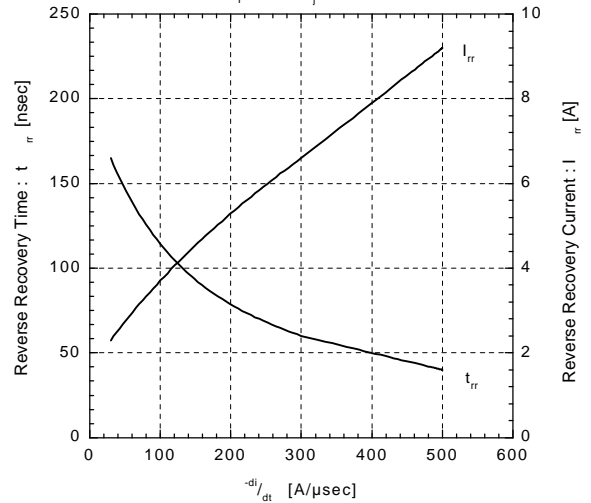
Typical Short Circuit Capability  
 $V_{CC}=400V, R_G=22\Omega, T_J=125^\circ C$



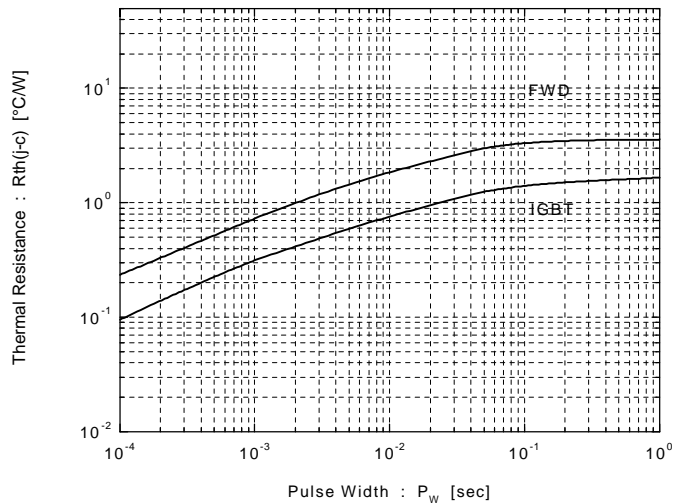
Forward Voltage vs. Forward Current



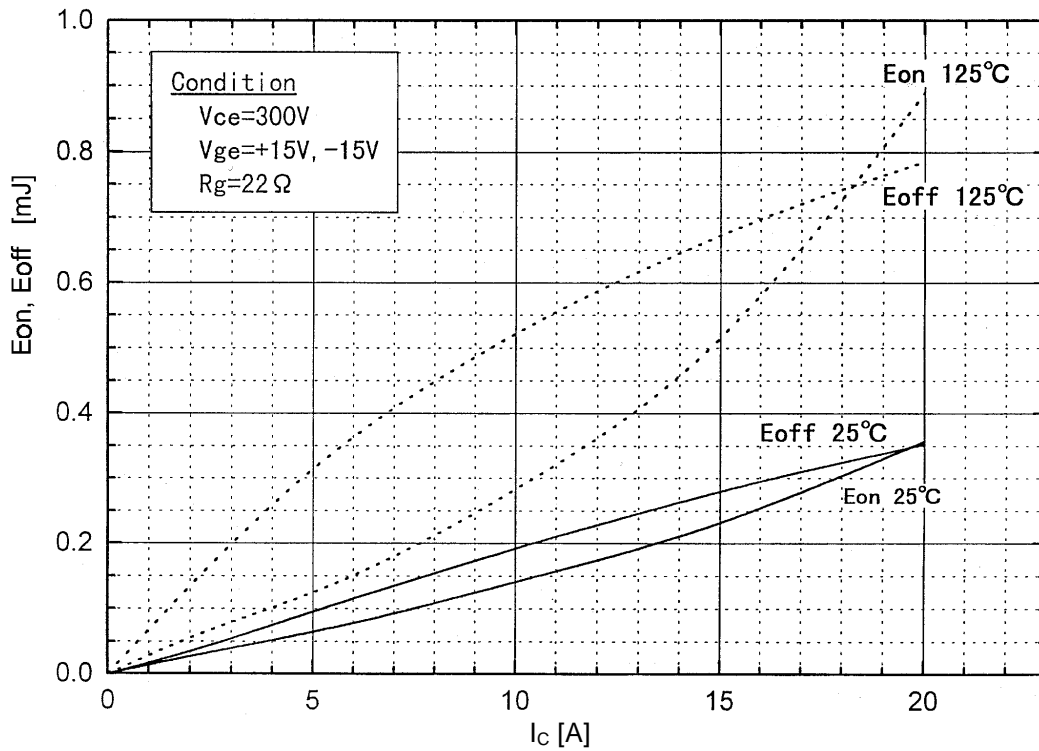
Reverse Recovery Characteristics vs.  $-di/dt$   
 $I_F=10A, T_J=125^\circ C$



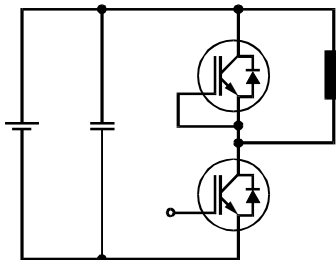
Transient Thermal Resistance



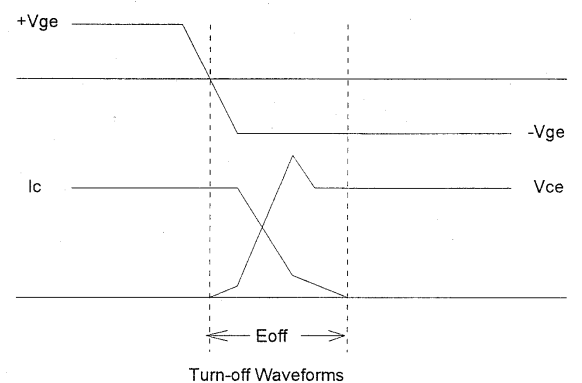
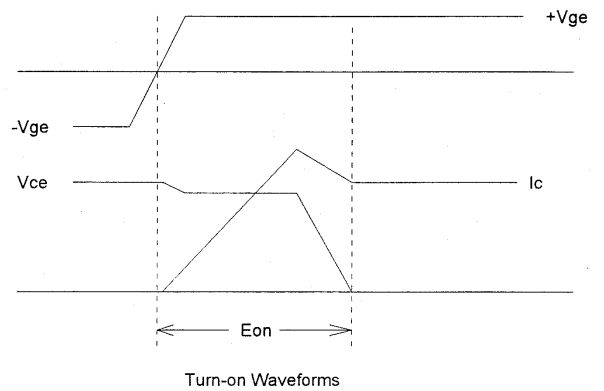
## Switching losses ( $E_{on}$ , $E_{off}$ vs. $I_c$ )



### Test Circuit



### Switching waveforms



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Datasheets for electronics components.